

Vishay Siliconix

RoHS

COMPLIANT

HALOGEN FREE

N-Channel 30 V (D-S) MOSFET

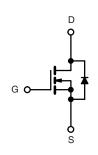
PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)	
30	0.0051 at V _{GS} = 10 V	50 ^d	21.7	
30	0.0063 at V _{GS} = 4.5 V	50 ^d	21.7	

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % $\rm R_{g}$ and UIS Tested
- Compliant to RoHS Directive 2002/95/EC •

APPLICATIONS

- Power Supply
- Secondary Synchronous Rectification
- DC/DC Converter ٠



Ο GDS Top View

Ordering Information: SUP50N03-5m1P-GE3 (Lead (Pb)-free and Halogen-free)

TO-220AB

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_{C} = 25 \ ^{\circ}C$, unless oth	erwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	30	v	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current (T ₁ = 150 °C)	T _C = 25 °C	1-	50 ^d		
Continuous Drain Current $(1) = 150^{\circ}$ C)	T _C = 70 °C	I _D	50 ^d	A	
Pulsed Drain Current		I _{DM}	100		
Avalanche Current		I _{AS}	40		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	80	mJ	
	T _C = 25 °C	Р	59.5 ^b		
Maximum Power Dissipation ^a	T _A = 25 °C ^c	– P _D –	2.7	- W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	46	°C/W	
Junction-to-Case (Drain)	R _{thJC}	2.1	0/10	

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.c. When mounted on 1" square PCB (FR-4 material).

d. Package limited.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-						
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1		2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA	
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50	μA	
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
Ducin Course On Chata Decistor and	_	V _{GS} = 10 V, I _D = 22 A		0.0042	0.0051	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 20 A		0.0052	0.0063		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		110		S	
Dynamic ^b	•		•	•			
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz		2780		pF	
Output Capacitance	C _{oss}			641			
Reverse Transfer Capacitance	C _{rss}			260			
Total Gate Charge ^c	Qg	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		44	66		
Iotal Gate Gharge				21.7	32.6	nC	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 15 V, V_{GS} = 4.5 V, I_{D} = 20 A		7			
Gate-Drain Charge ^c	Q _{gd}			6.7			
Gate Resistance	Rg	f = 1 MHz	0.4	2	4	Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	16		
Rise Time ^c	t _r	V_{DD} = 15 V, R_{L} = 1.5 Ω		9	18	-	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 10$ Å, $V_{GEN} = 10$ V, $R_g = 1$ Ω		35	53	ns	
Fall Time ^c	t _f			9	18		
Drain-Source Body Diode Ratings a	nd Characteris	stics $T_C = 25 \ ^{\circ}C^b$	•	•			
Continuous Current	۱ _S				50	٨	
Pulsed Current	I _{SM}				100	A	
Forward Voltage ^a	V _{SD}	I _F = 10 A, V _{GS} = 0 V		0.75	1.5	V	
Reverse Recovery Time	t _{rr}			34	51	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 10 A, dl/dt = 100 A/μs		2	3	Α	
Reverse Recovery Charge	Q _{rr}			34	51	nC	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

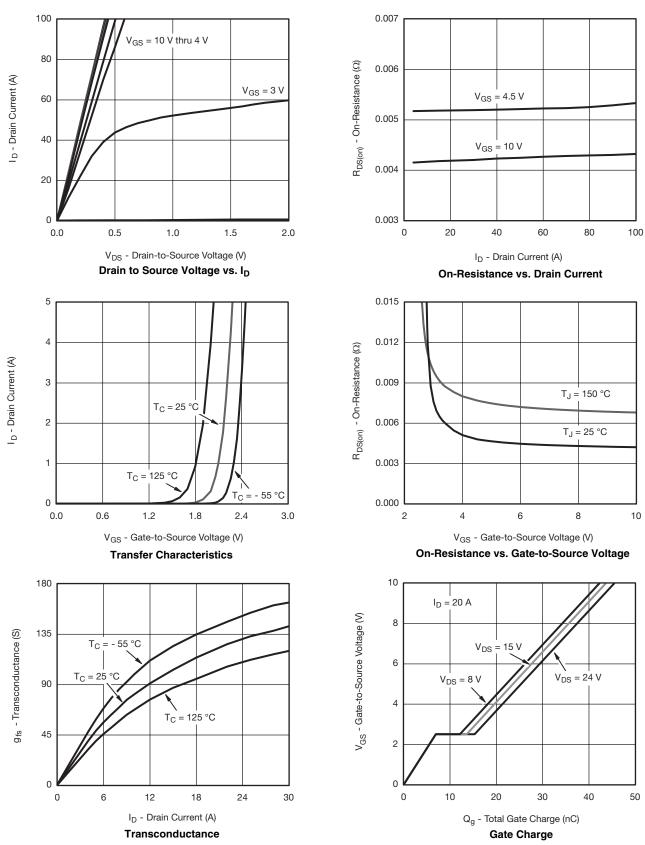
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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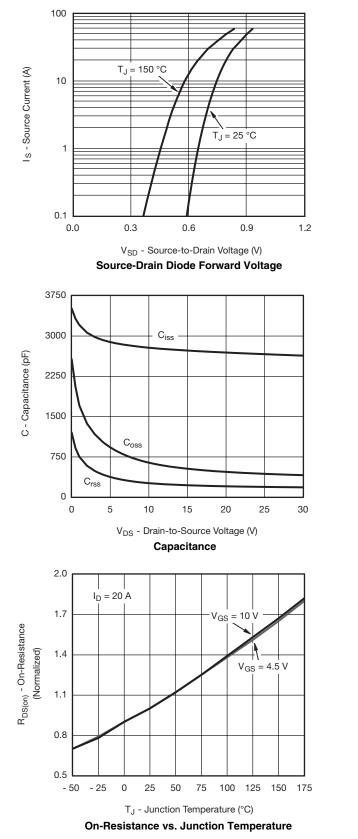
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

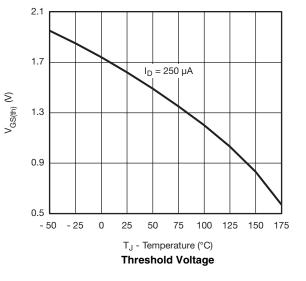


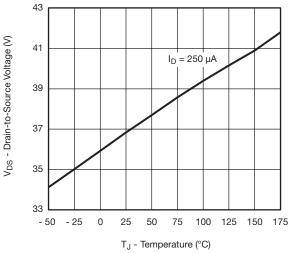
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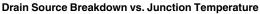


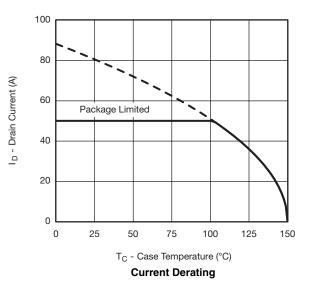
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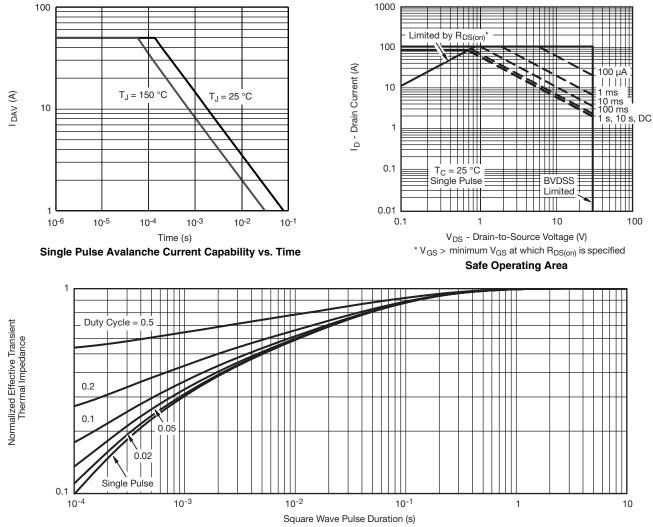




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Normalized Thermal Transient Impedance, Junction-to-Case

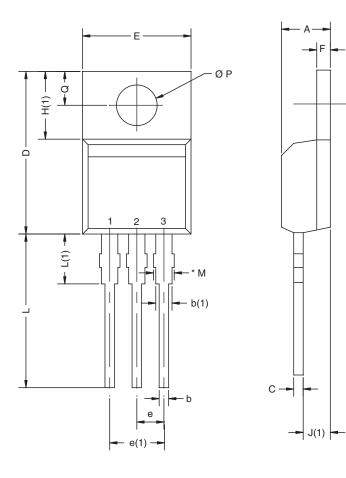
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg266570.



Package Information

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TO-220AB



	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
Е	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØΡ	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
	0416-Rev. M,		0.102	0.11

Note

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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